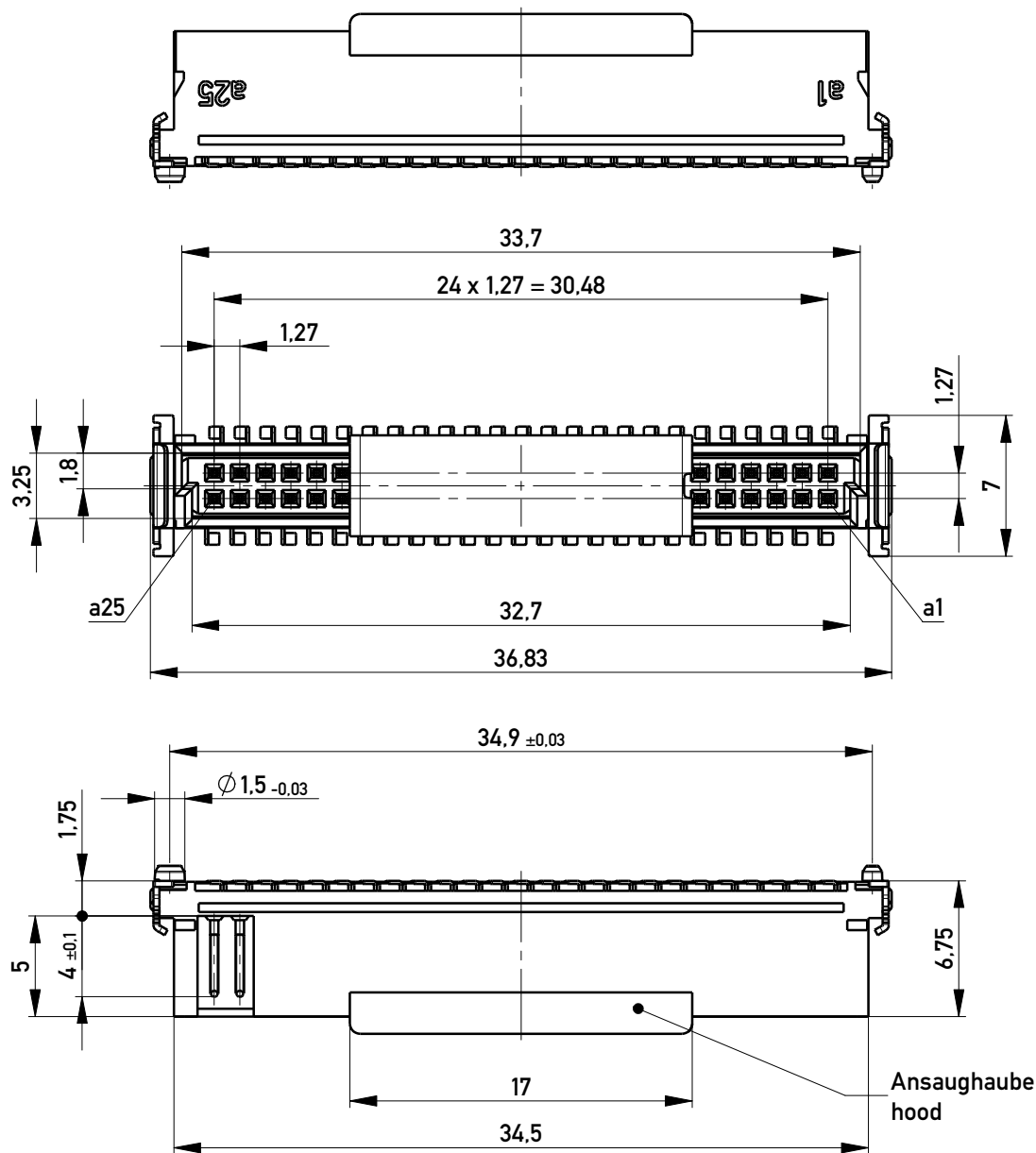
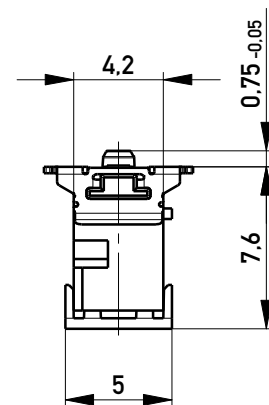
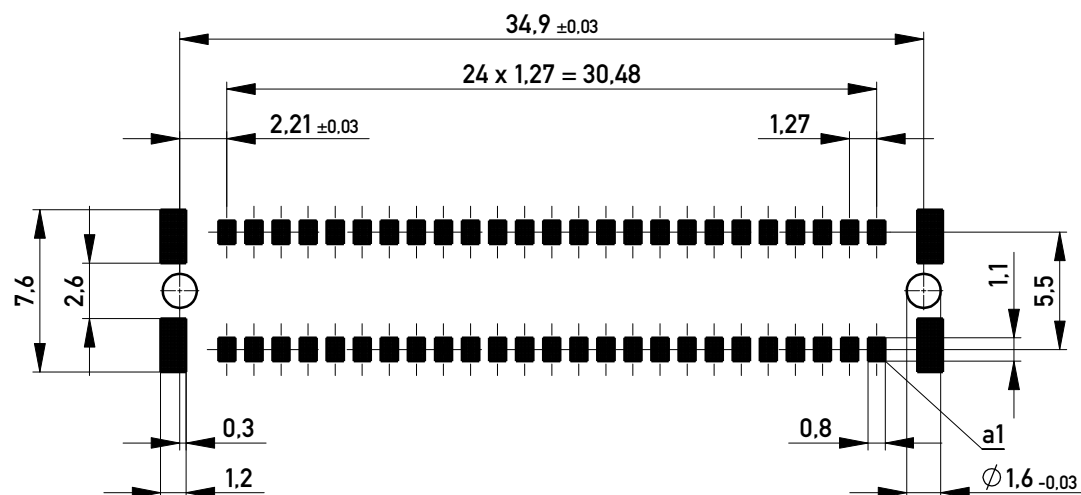




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



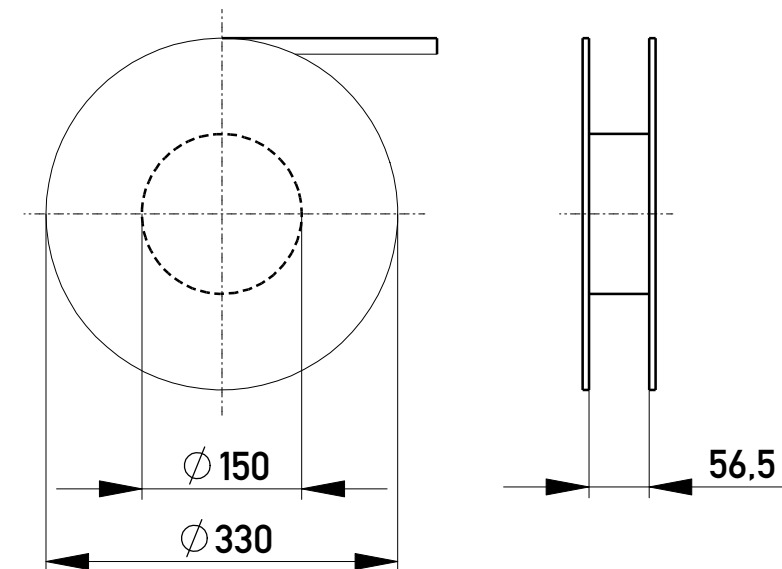
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

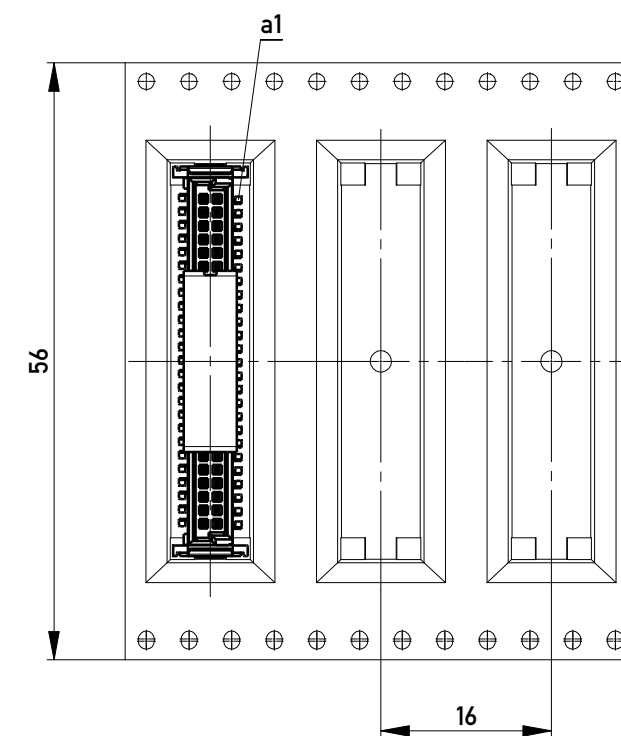
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt in Gurtverpackung - Tape on Reel Packaging
Verpackungseinheit: 280 Stück - Packaging unit: 280 pcs

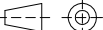


Abspulrichtung - Reel off Direction



BA 7-13 - 8mm Bauhöhe
type 7-13 - Low Profile

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Information:				Tolerances		 All Dimensions in mm		Scale 3:1			
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						Messerl. SMC-Q 50-SMD-BA7-13					
						Male SMC-Q 50-SMD-type7-13					
B			18.08.2008			www.ERNI.com		154820			I
Index			Date			Class SMCQ			A3		

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